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### IRF644B

# **N-Channel BFET MOSFET 250 V, 14 A, 280 m**Ω

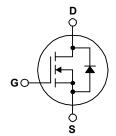
### Description

These N-Channel enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, planar, DMOS technology. This advanced technology has been especially tailored to minimize onprovide superior resistance, switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters and switch mode power supplies.

### **Features**

- 14 A, 250 V,  $R_{DS(on)}$  = 280 m $\Omega$  @  $V_{GS}$  = 10 V
- Low gate charge (Typ. 47 nC)
- Low Crss (Typ. 30 pF)
- · Fast Switching
- 100% Avalanche Tested
- · Improved dv/dt Capability





# **Absolute Maximum Ratings** T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter		IRF644B_FP001	Unit	
V <sub>DSS</sub>	Drain-Source Voltage		250	V	
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C	<b>(</b> )	14	Α	
	- Continuous (T <sub>C</sub> = 100°	8.9	Α		
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	56	Α	
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	480	mJ	
I <sub>AR</sub>	Avalanche Current	(Note 1)	14	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	13.9	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.8	V/ns	
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25°C) - Derate Above 25°C		139	W	
			1.11	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
T <sub>L</sub>	Maximum Lead Temperature for Soldering 1/8" from Case for 5 Seconds	<b>]</b> ,	300	°C	

### **Thermal Characteristics**

Symbol	Parameter	IRF644B-FP001	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.9	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	°C/W

# **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
IRF644B-FP001	IRF644B	TO-220	Tube	N/A	N/A	50 units

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
Off Cha	aracteristics						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		250			V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenced to 2	5°C	-	0.24		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V				10	μΑ
		V <sub>DS</sub> = 200 V, T <sub>C</sub> = 125°C				100	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V				100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V			1	-100	nA
On Cha	racteristics						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA		2.0		4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7.0 A		-	0.22	0.28	Ω
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 7.0 A			11.7		S
C <sub>iss</sub>	Input Capacitance Output Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz			1250 150	1600 195	pF pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1.5 WH 12			30	40	pF
	ing Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD}$ = 125 V, $I_{D}$ = 14 A, $R_{G}$ = 25 $\Omega$			20	50	ns
t <sub>r</sub>	Turn-On Rise Time				115	240	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	(No	ote 4)		150	310	ns
t <sub>f</sub> Q <sub>g</sub>	Turn-Off Fall Time Total Gate Charge				95 47	200 60	ns nC
$\frac{Q_g}{Q_{gs}}$	Gate-Source Charge	$V_{DS} = 200 \text{ V}, I_{D} = 14 \text{ A},$		-	6.2	00	nC
Q <sub>gs</sub> Q <sub>gd</sub>	Gate-Drain Charge	V <sub>GS</sub> = 10 V	ote 4)		23		nC
⊶ga	Gate-Drain Charge	(111	510 4)		23	-	110
Drain-S	Source Diode Characteristics a	nd Maximum Ratings					
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				1	14	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode F				-	56	Α
$V_{SD}$	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 14 A			I	1.5	>
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 14 A,			240	-	ns
_		all / alk = 400 A /	-		4 00		_

# $Q_{rr}$

Reverse Recovery Charge

 $dI_F / dt = 100 A/\mu s$ 

1.96

μС

**Notes:**1. Repetitive rating : pulse-width limited by maximum junction temperature. 2. L = 3.9 mH, I<sub>AS</sub> = 14 A, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25  $\Omega$ , starting T<sub>J</sub> = 25°C. 3. I<sub>SD</sub>  $\leq$  14 A, di/dt  $\leq$  300 A/µs, V<sub>DD</sub>  $\leq$  BV<sub>DSS</sub>, starting T<sub>J</sub> = 25°C. 4. Essentially independent of operating temperature.

# **Typical Characteristics**

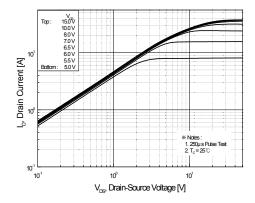


Figure 1. On-Region Characteristics

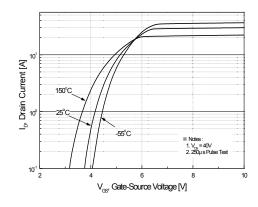


Figure 2. Transfer Characteristics

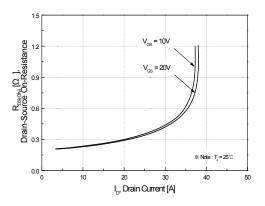


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

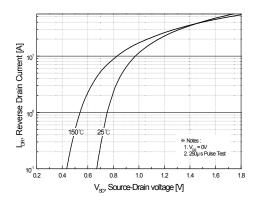


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

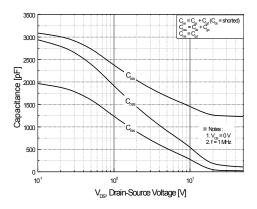


Figure 5. Capacitance Characteristics

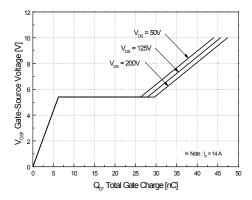


Figure 6. Gate Charge Characteristics

# Typical Characteristics (Continued)

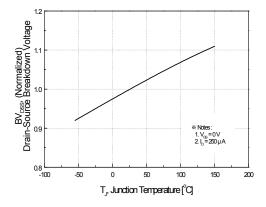


Figure 7. Breakdown Voltage Variation vs Temperature

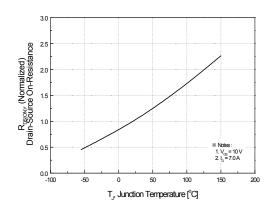


Figure 8. On-Resistance Variation vs Temperature

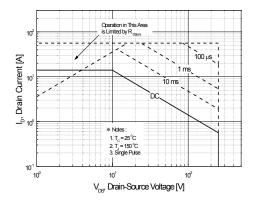


Figure 9. Maximum Safe Operating Area

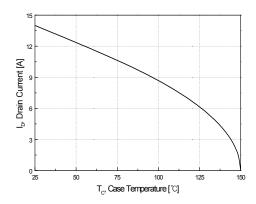


Figure 10. Maximum Drain Current vs Case Temperature

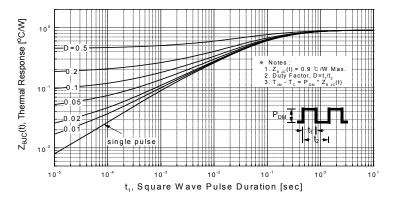


Figure 11. Transient Thermal Response Curve

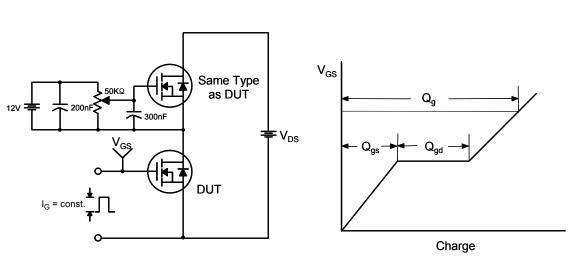


Figure 12. Gate Charge Test Circuit & Waveform

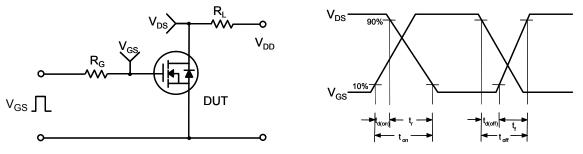


Figure 13. Resistive Switching Test Circuit & Waveforms

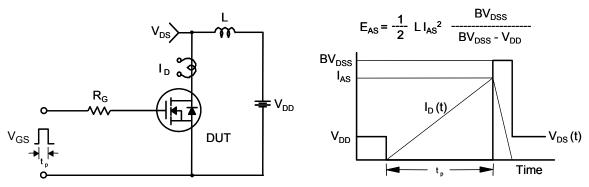


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

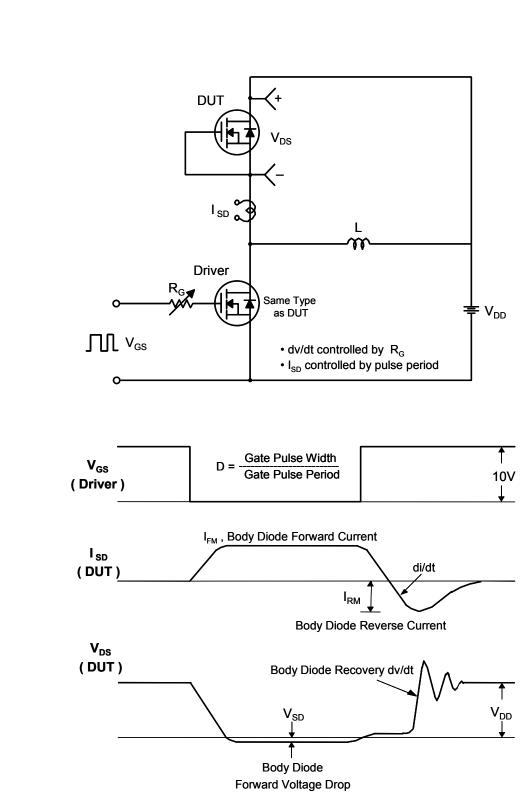
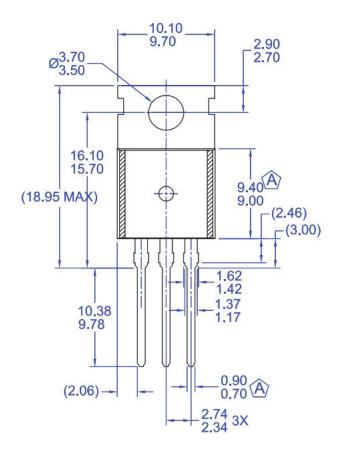
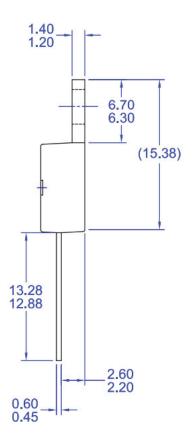
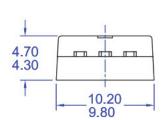


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

### **Mechanical Dimensions**







### NOTES:

- (A) CONFORMS TO JEDEC TO-220 VARIATION AB EXCEPT WHERE NOTED
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D) DRAWING FILE/REVISION: MKT-TO220Y03REV1

Figure 16. TO220, Molded, 3-Lead, Jedec Variation AB

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